

Features

- 3.2 x 2.7 SMD LED
- Low power consumption
- General purpose leads
- Bulk, Available on tape and reel
- Fast response time
- High photo sensitivity
- Small junction capacitance

Applications

- High speed photo detector
- Automatic door sensor
- Security system
- Industrial equipment
- Infrared application system

Description

The IN-S32GTNPD is a popular 3.2 x 2.7mm package with versatile design capabilities. It is a PCB type LED which can be used in various applications. Due to its **black** epoxy, the device is matched to visible light and infrared radiation.

Recommended Solder Pattern

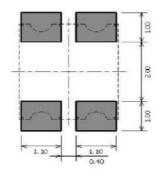
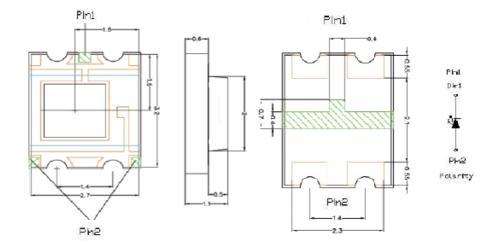


Figure 1. IN-S32GTNPD Solder Pattern

Package Dimensions in mm



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25 mm (.010 $^{\prime\prime}$) unless otherwise noted.

Figure 1. IN-S32GTNPD Package Dimensions



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
VBR	Reverse Breakdown Voltage	35	V	1
Topr	Operating Temperature	-40~+85	°C	
Tstg	Storage Temperature	-40~+85	$^{\circ}$	
Tsol	Soldering Temperature	260	°C	2
PD	Total Power Dissipation	150	mW	

Notes

1. Test conditions : $I_R=100\mu A$, $Ee=0mW/cm_2$.

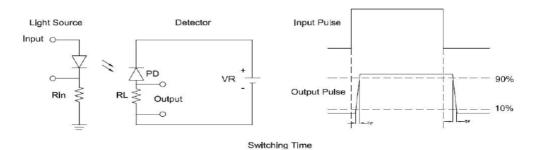
2. Soldering time ≤ 5 seconds.

Electro-Optical Characteristics

Symbol	Parameters	Test conditions	Min	Тур	Max	Units
λD	Rang of Spectral Bandwidth		700	-	1100	nm
λР	Wavelength of Peak Sensitivity		-	940		nm
VBR	Reverse Breakdown Voltage	E _e =0mW/cm ₂ IR=100uA	35	-	-	V
Voc	Open-Circuit Voltage	Ee=1mW/cm ² λ _P =940nm	ı	0.42	-	V
Isc	Short-Circuit Current	Ee=1mW/cm² λ _P =940nm	-	8.5	-	uA
lo	Dark Current	Ee=0mW/cm ² VR=10V	ı	-	10	nA
IL	Reverse Light Current	Ee=1mW/cm ² λ _P =940nm, VR=5V	5.7	-	16	uA
tr	Rise Time	V _R =5V,	-	10	-	uS
tf	Fall Time	RL=1KΩ	-	10	-	uS
Ст	Transition Capacitance	E _e =0mW/cm ² f=1MHz, VR=5V		4.76		pF

Notes:

Test circuit:





ESD Precaution

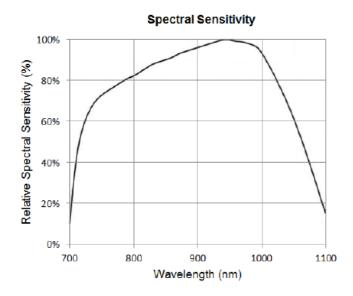
ATTENTION: Electrostatic Discharge (ESD) protection

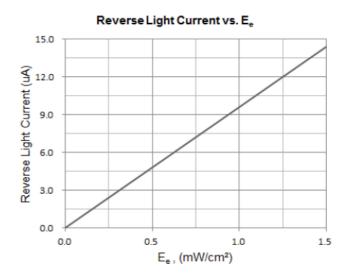


The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Typical Characteristic Curves



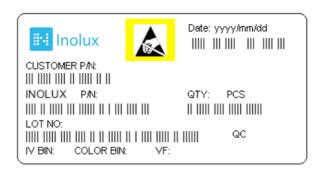




Ordering Information

F	Product	Symbol	Parameters	Test conditions	Min	Тур	Max	Units	Orderable Part Number
IN-S	332GTNPD	lι	Reverse Light Current	Ee=1mW/cm ² λ _P =940nm, VR=5V	5.7	1	16	uA	IN-S32GTNPD

Label Specifications



Inolux P/N:

1	N	-	S	3	2	G	Т	N	PD	-	-	-	-	-
			Material	Pacl	kage	Variation	Orientation	Lens	Color				miz np-o	
Ino SM	lux 1D		PCB - S	32G	=3.2x2	.7 1.1mm	T = Top Mount	N = Black	PD = Photo Diode					

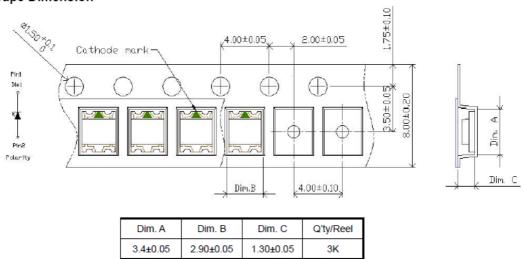
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \	Month	Data	Corial	
Tracker		Year (2017, 2018,)				Date	Serial

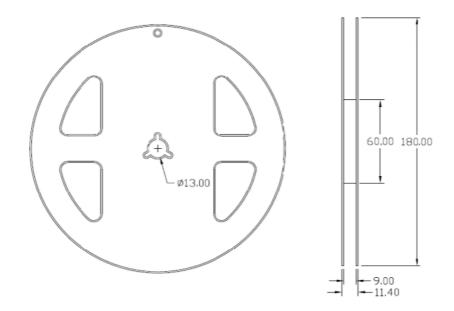


Packaging Information:

Packaging
Tape Dimension

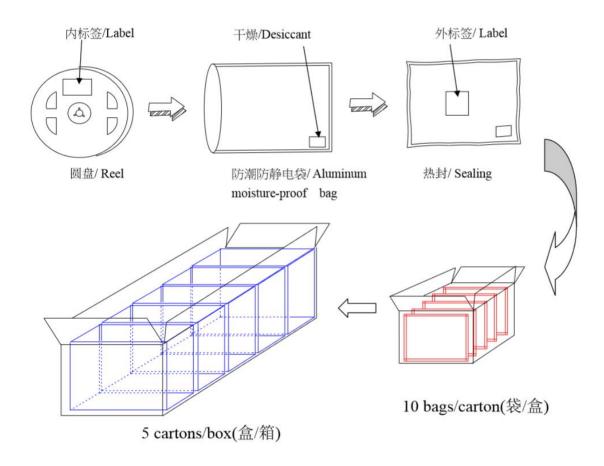


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	3000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Otherno			

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

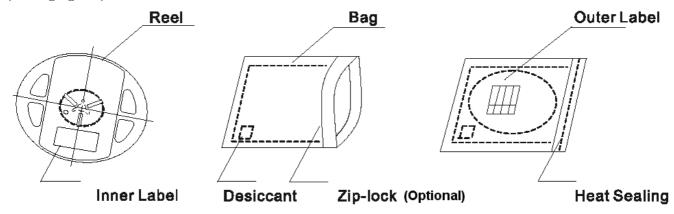


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

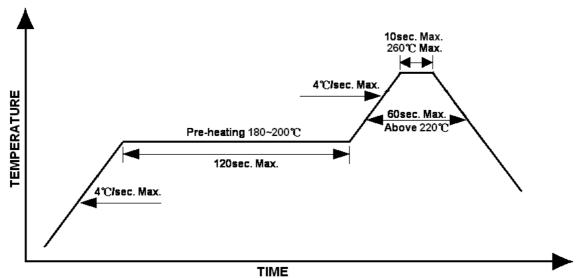
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 μ s,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	01-31-2019

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VTP4085H SFH 2400 OP913WSL OPF794 PD70-01C/TR7 LTR-536AD VTP8651H VTD206KH VTB1013H BPV23NF OP905 LTR516AD BPW 34 FS-Z VTD34FH QSB34CGR SFH 2500 FA SFH 213 FA PD15-22C/TR8 VEMD5510C SFH 2200 VEMD5510CF
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